Technical Data
Data Sheet N1094, Rev. B

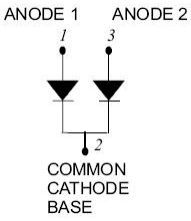
160CMQ…SERIES SCHOTTKY RECTIFIER

TO-249AA

Features

- **150 °C T_J operation**
- **Isolated heatsink**
- **Low profile, high current package**
- **Center tap module**
- **Low forward voltage drop**
- **High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance**
- **High frequency operation**
- **Guard ring for enhanced ruggedness and long term reliability**
- **Baseplate: Nickel plated; Terminals: Nickel plated**
- **This is a Pb − Free Device**
- **All SMC parts are traceable to the wafer lot**
- **Additional testing can be offered upon request**

Schematic & Pin Configuration



Applications

- **Switching power supply**
- **Converters**
- **Free-Wheeling diodes**
- **Reverse battery protection**

Maximum Ratings:

Characteristics	Symbol	Condition	Max.		Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	-	35	160CMQ035	V
			40	160CMQ040	
			45	160CMQ045	
Average Rectified Forward Current	$I_{F\ (AV)}$	50% duty cycle @T_C =71°C, rectangular wave form	80(Per Leg) 160(Per Device)		A
Peak One Cycle Non-Repetitive Surge Current	I_{FSM}	8.3 ms, half Sine pulse	900		A
Non-Repetitive Avalanche Energy (Peg Leg)	E_{AS}	T_J=25℃,I_{AS}=16A,L=0.84mH	108		mJ
Repetitive Avalanche Current(Peg Leg)	I_{AR}	Current decaying linearly to zero in 1 μsec Frequency limited by T_J max. V_A=1.5×V_R typical	16		A

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Electrical Characteristics:

Characteristics	Symbol	Condition	Typ.	Max.	Units
Forward Voltage Drop(Peg Leg)*	V_{F1}	@ 80A, Pulse, T_J = 25 °C @ 160A, Pulse, T_J = 25 °C	0.60 -	0.64 0.86	V
	V_{F2}	@ 80A, Pulse, T_J = 125 °C @ 160A, Pulse, T_J = 125 °C	0.56 -	0.60 0.76	V
Reverse Current(Peg Leg)*	I_{R1}	@V_R = rated VR T_J = 25 °C	0.1	5	mA
	I_{R2}	@V_R = rated VR ,T_J = 125 °C	80	200	mA
Junction Capacitance(Peg Leg)	C_T	@V_R = 5V, T_C = 25 °C f_{SIG} = 1MHz	2000	2600	pF
Voltage Rate of Change	dv/dt	-	-	10,000	V/µs

* Pulse width < 300 µs, duty cycle < 2%

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	T_J	-	-55 to +150	°C
Storage Temperature	T_{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case (Per Leg)	$R_{\theta JC}$	DC operation	1.0	°C/W
Typical Thermal Resistance Junction to Case (Per Package)	$R_{\theta JC}$	DC operation	0.50	°C/W
Typical Thermal Resistance, case to Heat Sink	$R_{\theta cs}$	Mounting surface, smooth and greased	0.10	°C/W
Mounting Torque	T_M	-	40(min) 58(max)	Kg-cm
Approximate Weight	wt	-	58	g
Case Style	TO-249AA			

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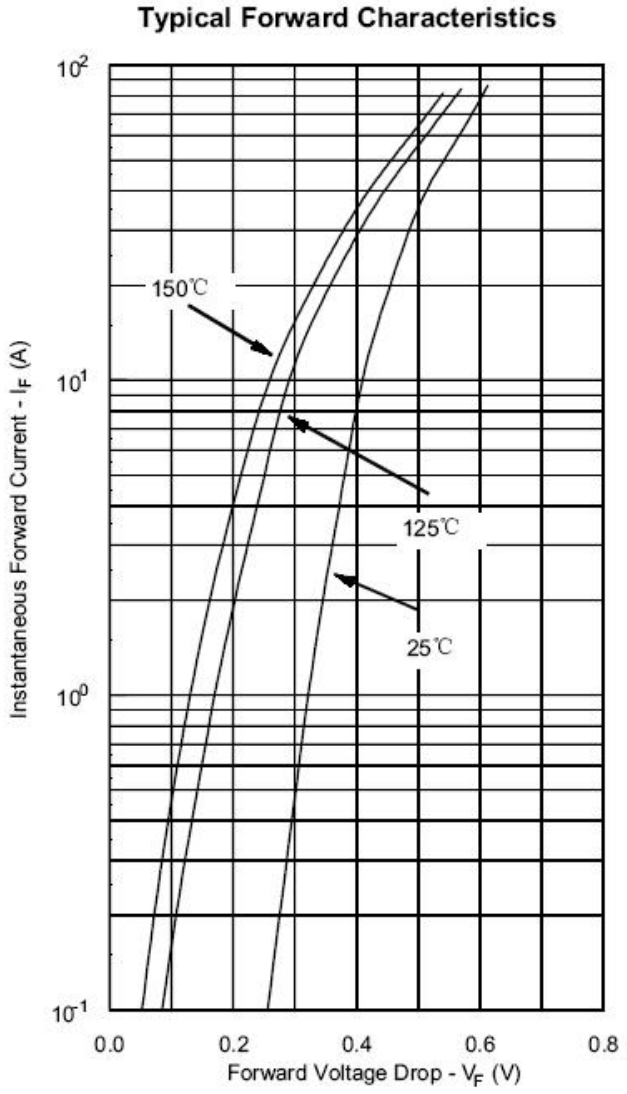
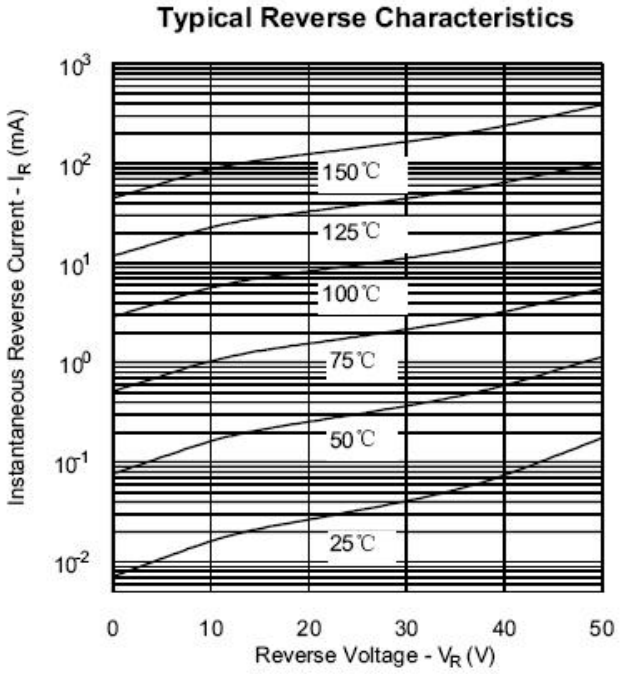
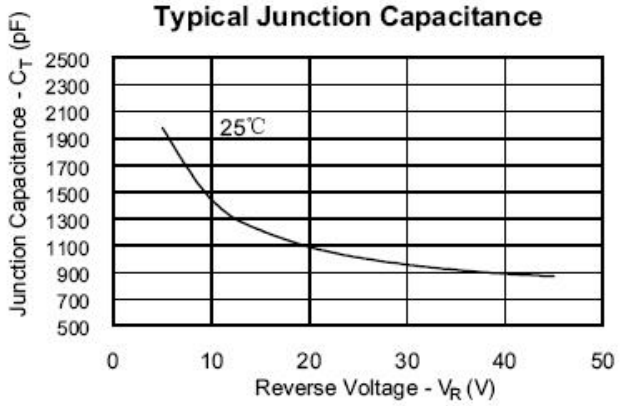
Ratings and Characteristics Curves







Ordering Information

Device	Package	Shipping
160CMQ SERIES	TO-249AA(Pb-Free)	24pcs/ box

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

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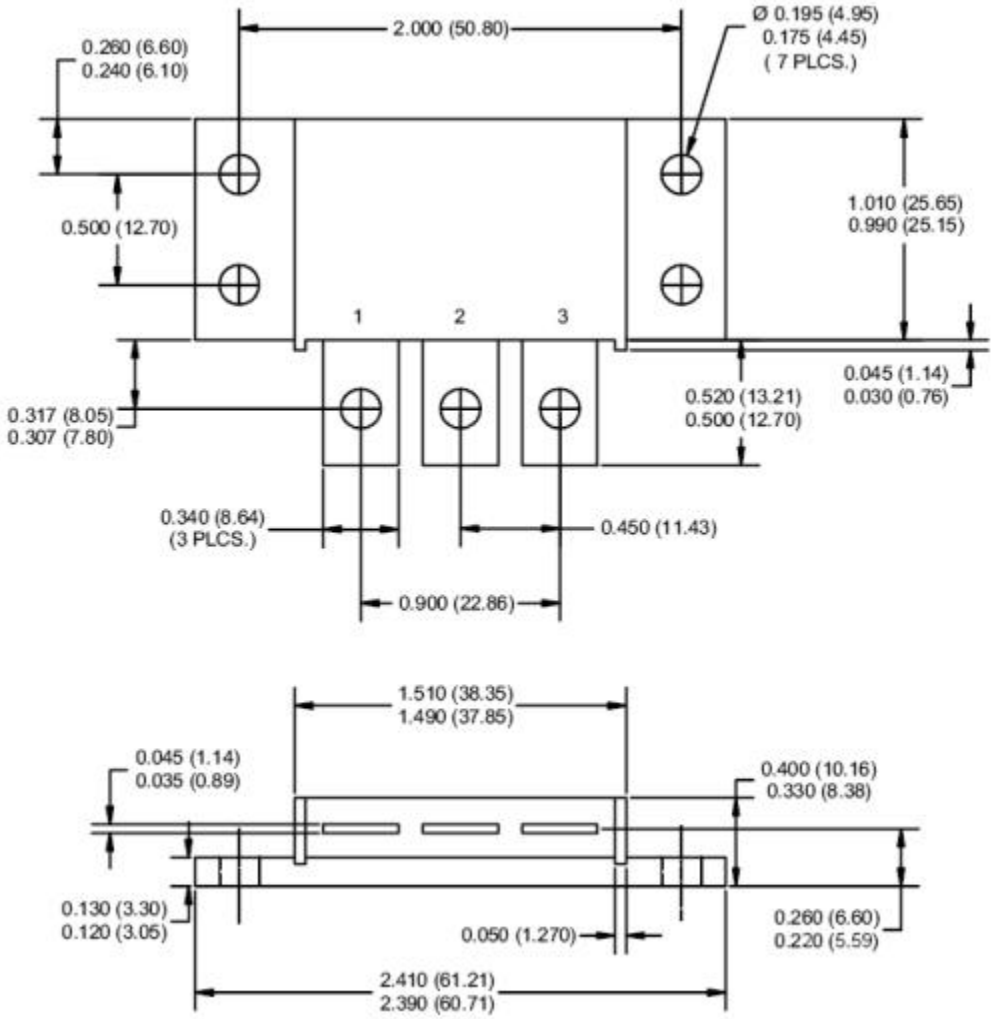
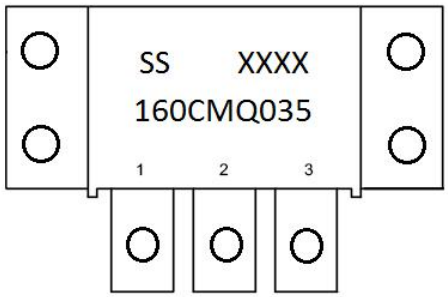
Mechanical Dimensions TO-249AA (Inches/Millimeters)



Marking Diagram



Where XXXX is YYWW

1st row SS YYWW
2nd row 160CMQ035
3rd row 1 2 3 (pin)
SS = SS
YY = Year
WW = Week

Cautions: Molding resin
Epoxy resin UL:94V-0

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